

DB2W319

Silicon epitaxial planar type

For rectification

■ Features

- Low forward voltage V_F
- Low terminal capacitance C_t
- Contributes to miniaturization of sets, reduction of component count.
- Eco-friendly Halogen-free package

■ Packaging

Embossed type (Thermo-compression sealing): 3000 pcs / reel (standard)

■ Package

- Code
Mini2-F3-B
- Pin Name
1: Cathode
2: Anode

■ Marking Symbol: 3W

■ Absolute Maximum Ratings $T_a = 25^\circ\text{C}$

Parameter	Symbol	Rating	Unit
Reverse voltage	V_R	30	V
Forward current (Average) *1	$I_{F(AV)}$	3	A
Non-repetitive peak forward surge current *2	I_{FSM}	30	A
Junction temperature	T_j	125	$^\circ\text{C}$
Storage temperature	T_{stg}	-55 to +125	$^\circ\text{C}$

Note) *1: Mounted on an alumina PC board (Board: 50 mm × 50 mm)

*2: 50 Hz sine wave 1 cycle (Non-repetitive peak current)

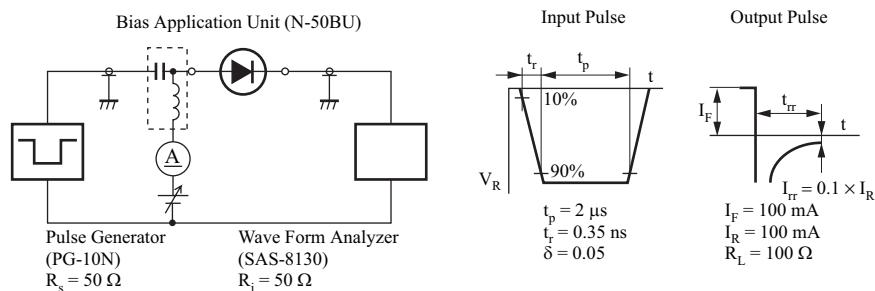
■ Electrical Characteristics $T_a = 25^\circ\text{C} \pm 3^\circ\text{C}$

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Forward voltage	V_F	$I_F = 3\text{ A}$		0.42	0.49	V
Reverse current	I_R	$V_R = 30\text{ V}$		50	200	μA
Terminal capacitance	C_t	$V_R = 10\text{ V}$, $f = 1\text{ MHz}$		70		pF
Reverse recovery time *	t_{rr}	$I_F = 100\text{ mA}$, $I_{rr} = 0.1 \times I_R$, $R_L = 100\ \Omega$		23		ns

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

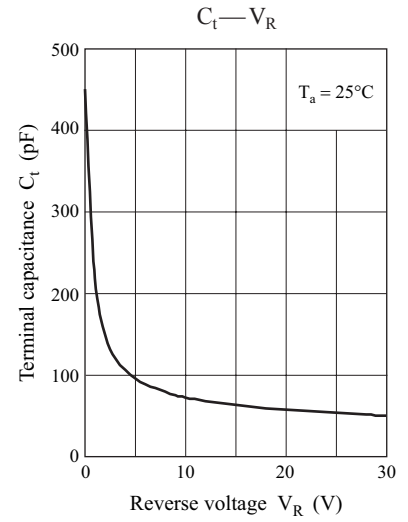
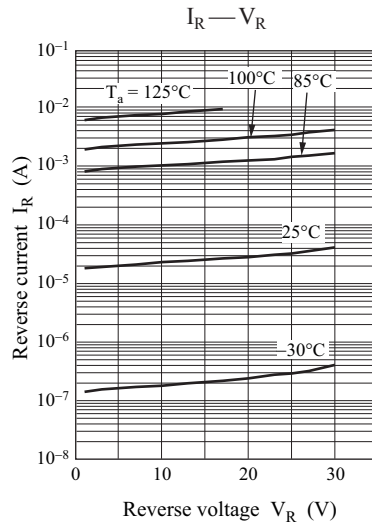
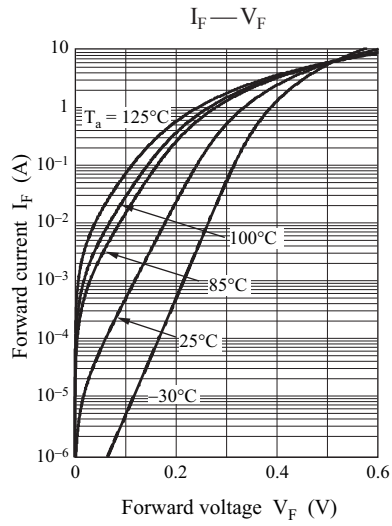
2. This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.

3. *: t_{rr} measurement circuit



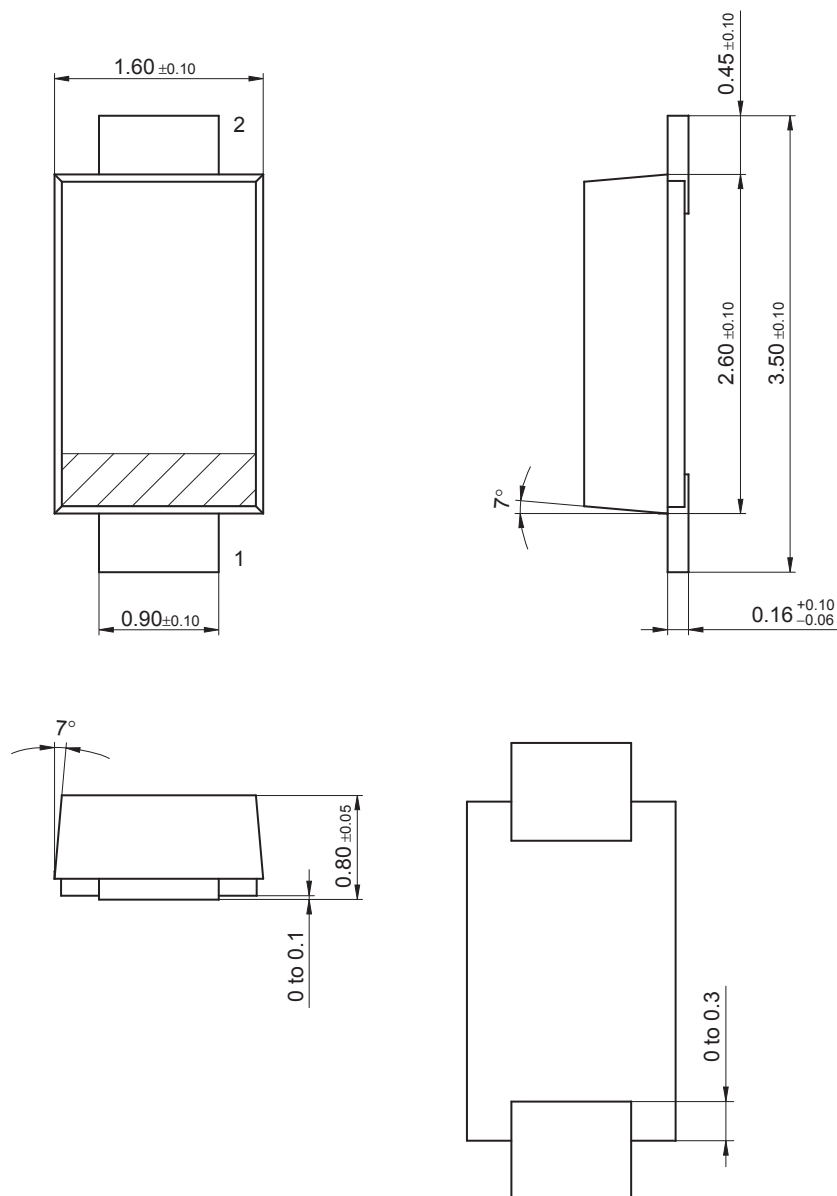
DB2W319

Panasonic



Mini2-F3-B

Unit: mm



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